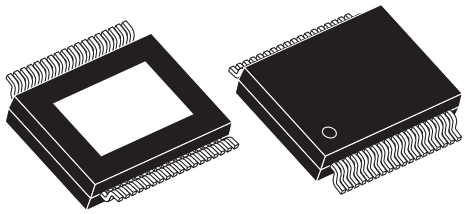
TDA7491MV

25 W mono BTL class-D audio amplifier

Datasheet - production data



PowerSSO-36 with exposed pad down

Description

The TDA7491MV is a mono BTL class-D audio amplifier with single power supply designed for LCD TVs and monitors.

Thanks to the high efficiency and an exposed-pad-down (EPD) package no heatsink is required.

Furthermore, the filterless operation allows a reduction in the external component count.

The TDA7491MV is pin to pin compatible with the TDA7491P, TDA7491LP and TDA7491HV for the left channel.

Features

- 20 W continuous output power: R_L = 8 Ω, THD = 10% at V_{CC} = 18 V
- 25 W continuous output power: R_L = 6 Ω, THD = 10% at V_{CC} = 16 V
- Wide range single supply operation (5 V - 18 V)
- High efficiency (η = 90%)
- Four selectable, fixed gain settings of nominally 20 dB, 26 dB, 30 dB and 32 dB
- Differential inputs minimize common-mode noise
- Filterless operation
- No ‘pop’ at turn-on/off
- Standby and mute features
- Short-circuit protection
- Thermal overload protection
- Externally synchronizable

Table 1. Device summary

Order code	Operating temp. range	Package	Packaging
TDA7491MV13TR	- 40 to 85 °C	PowerSSO-36 EPD	Tape and reel

This is information on a product in full production. www.st.com

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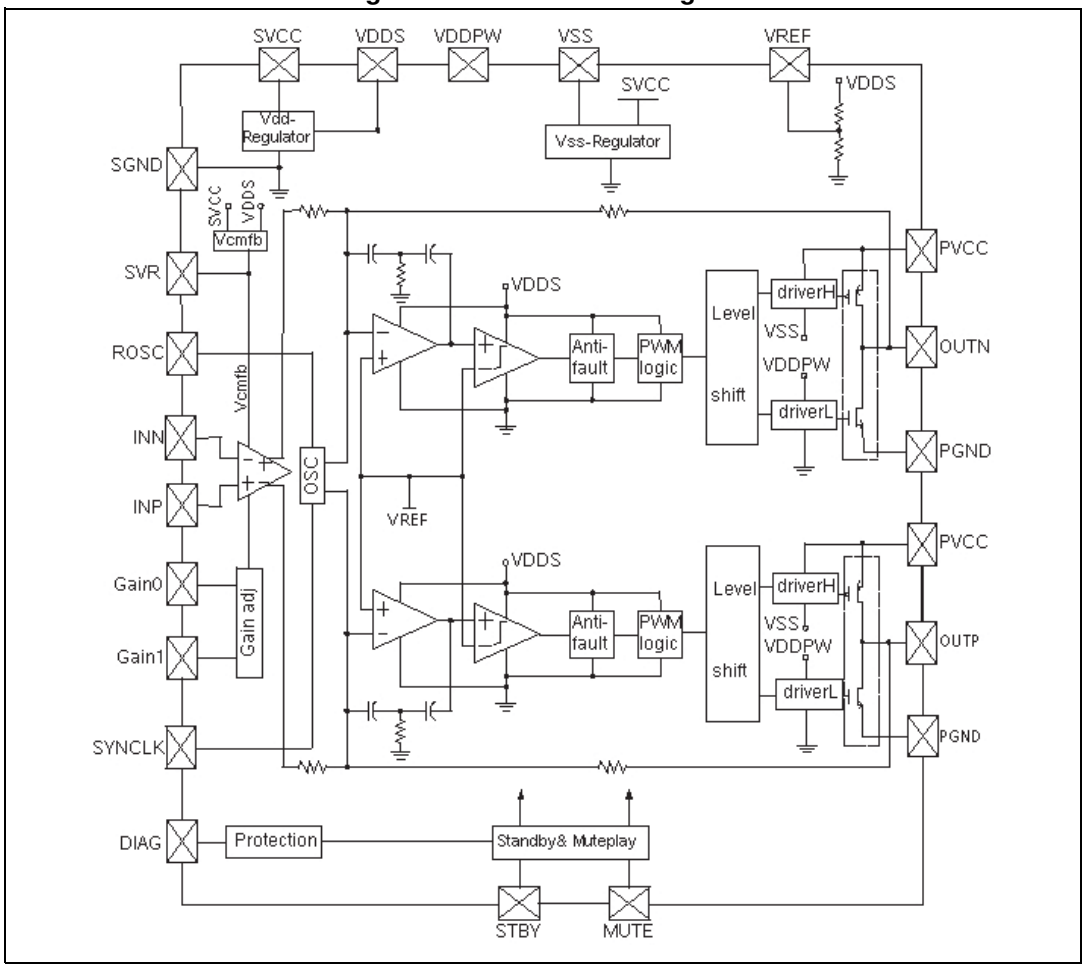
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1 Device block diagram

Figure 1 shows the block diagram of the TDA7491MV.

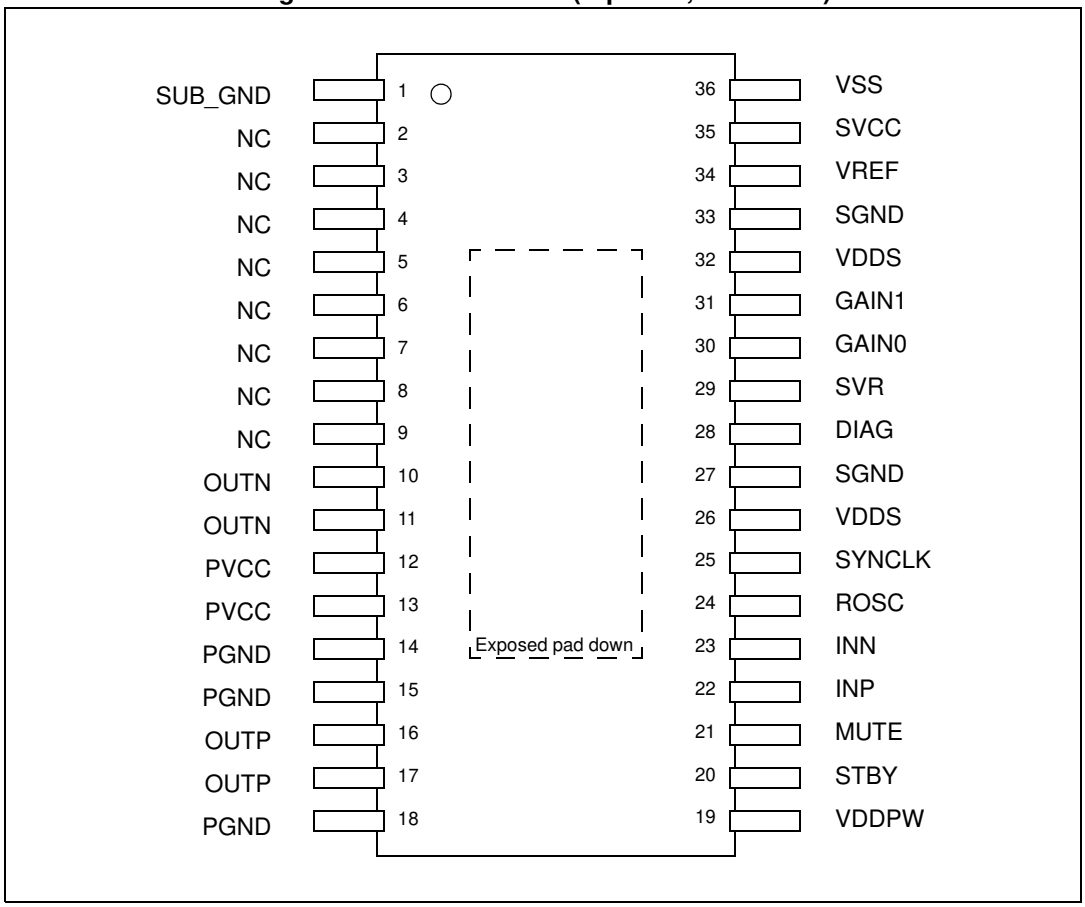
Figure 1. Internal block diagram



2 Pin description

2.1 Pin out

Figure 2. Pin connection (top view, PCB view)



2.2 Pin list

Table 2. Pin description list

Pin n°	Name	Type	Description
1	SUB_GND	POWER	Connect to the frame
2, 3	NC	-	No internal connection
4, 5	NC	-	No internal connection
6, 7	NC	-	No internal connection
8, 9	NC	-	No internal connection
10,11	OUTN	OUT	Negative PWM output
12,13	PVCC	POWER	Power supply
14,15	PGND	POWER	Power stage ground
16,17	OUTP	OUT	Positive PWM output
18	PGND	POWER	Power stage ground
19	VDDPW	OUT	3.3 V (nominal) regulator output referred to ground for power stage
20	STBY	INPUT	Standby mode control
21	MUTE	INPUT	Mute mode control
22	INP	INPUT	Positive differential input
23	INN	INPUT	Negative differential input
24	ROSC	OUT	Master oscillator frequency-setting pin
25	SYNCLCK	IN/OUT	Clock in/out for external oscillator
26	VDDS	OUT	3.3 V (nominal) regulator output referred to ground for signal blocks
27	SGND	POWER	Signal ground
28	DIAG	OUT	Open-drain diagnostic output
29	SVR	OUT	Supply voltage rejection
30	GAIN0	INPUT	Gain setting input 1
31	GAIN1	INPUT	Gain setting input 2
32	VDDS	POWER	To be connected to VDDS (pin 26)
33	SGND	POWER	Signal ground
34	VREF	OUT	Half VDDS (nominal) referred to ground
35	SVCC	POWER	Signal power supply
36	VSS	OUT	3.3 V (nominal) regulator output referred to power supply

3 Electrical specifications

3.1 Absolute maximum ratings

Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}	DC supply voltage for pins PVCCA, PVCCB, SVCC	24	V
T_{op}	Operating temperature	-40 to 85	°C
T_j	Junction temperature	-40 to 150	°C
T_{stg}	Storage temperature	-40 to 150	°C

3.2 Thermal data

Table 4. Thermal data

Symbol	Parameter	Min.	Typ.	Max.	Unit
$R_{th\ j\text{-}case}$	Thermal resistance, junction to case	-	2	3	°C/W
$R_{th\ j\text{-}amb}$	Thermal resistance, junction to ambient (mounted on recommended PCB)(1)	-	24	-	

1. FR4 with vias to copper area of 9 cm^2 (see also *Section 7.9: Heatsink requirements on page 26*).

3.3 Electrical specifications

Unless otherwise stated, the results in *Table 5* below are given for the conditions: V_{CC} = 18 V, R_L (load) = 8 Ω, R_{OSC} = R3 = 39 kΩ, C8 = 100 nF, f = 1 kHz, G_V = 20 dB, and T_{amb} = 25 °C.

Table 5. Electrical specifications

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
V_{CC}	Supply voltage for pins PVCC, SVCC	-	5	-	18	V
I_q	Total quiescent	Without LC filter	-	26	35	mA
I_{qSTBY}	Quiescent current in standby	-	-	2.5	5.0	µA
V_{OS}	Output offset voltage	Play mode	-150	-	150	mV
V_{OS}	Output offset voltage	Mute mode	-60	-	60	mV
I_{OCP}	Overcurrent protection threshold	R_L = 0 Ω	3	5	-	A
T_j	Junction temperature at thermal shutdown	-	-	150	-	°C
R_i	Input resistance	Differential input	55	60	-	kΩ
V_{OVP}	Overvoltage protection threshold	-	19	21	-	V

Table 5. Electrical specifications (continued)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
V_{UVP}	Undervoltage protection threshold	-	-	-	4	V
R_{dsON}	Power transistor on resistance	High side	-	0.2	-	Ω
		Low side	-	0.2	-	
P_o	Output power	THD = 10%	-	20	-	W
		THD = 1%	-	16	-	
P_o	Output power	R_L = 8 Ω, THD = 10% V_{CC} = 12 V	-	9.5	-	W
		R_L = 8 Ω, THD = 1% V_{CC} = 12 V	-	7.2	-	
P_o	Output power	R_L = 6 Ω, THD = 10% V_{CC} = 16 V	-	20	-	W
		R_L = 6 Ω, THD = 1% V_{CC} = 16 V	-	16	-	
P_D	Dissipated power	P_o = 20 W THD = 10%	-	2.0	-	W
η	Efficiency	P_o = 20 W	80	90	-	%
THD	Total harmonic distortion	P_o = 1 W	-	0.1	0.2	%
G_V	Closed loop gain	GAIN0 = L, GAIN1 = L	18	20	22	dB
		GAIN0 = L, GAIN1 = H	24	26	28	
		GAIN0 = H, GAIN1 = L	28	30	32	
		GAIN0 = H, GAIN1 = H	30	32	34	
ΔG_V	Gain matching	-	-1	-	1	dB
eN	Total input noise	A Curve, G_V = 20 dB	-	20	-	µV
		f = 22 Hz to 22 kHz	-	25	35	
SVRR	Supply voltage rejection ratio	fr = 100 Hz, Vr = 0.5 V, C_{SVR} = 10 µF	40	50	-	dB
T_r, T_f	Rise and fall times	-	-	50	-	ns
f_{SW}	Switching frequency	Internal oscillator	290	310	330	kHz
f_{SWR}	Output switching frequency	With internal oscillator (1)	250	-	-	kHz
		With external oscillator (2)	250	-	-	
V_{inH}	Digital input high (H)	-	2.3	-	-	V
V_{inL}	Digital input low (L)		-	-	0.8	
A_{MUTE}	Mute attenuation	V_{MUTE} = 1 V	60	80	-	dB

Table 5. Electrical specifications (continued)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Function mode	Standby, mute and play modes	V_{STBY} < 0.5 V, V_{MUTE} = X	Standby			-
		V_{STBY} > 2.5 V, V_{MUTE} < 0.8 V	Mute			-
		V_{STBY} > 2.5 V, V_{MUTE} > 2.5 V	Play			-

1. $f_{SW} = 10^6 / ((16 * R_{OSC} + 182) * 4)$ kHz, $f_{SYNCLK} = 2 * f_{SW}$ with R3 = 39 kΩ (see *Figure 18.*)
2. $f_{SW} = f_{SYNCLK} / 2$ with the frequency of the external oscillator.

4 Characterization curves

The following characterization curves were made using the TDA7491MV demo board. The LC filter for the 8-Ω load uses components of 33 µH and 220 nF.

All other test conditions are given along side the corresponding curves.

Figure 3. Output power vs. supply voltage

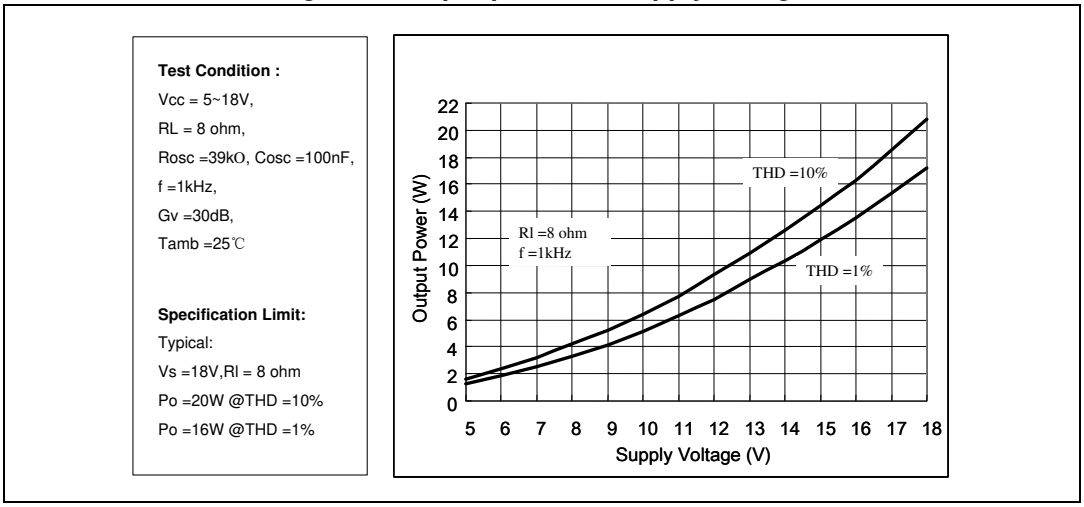


Figure 4. THD vs output power (1 kHz)

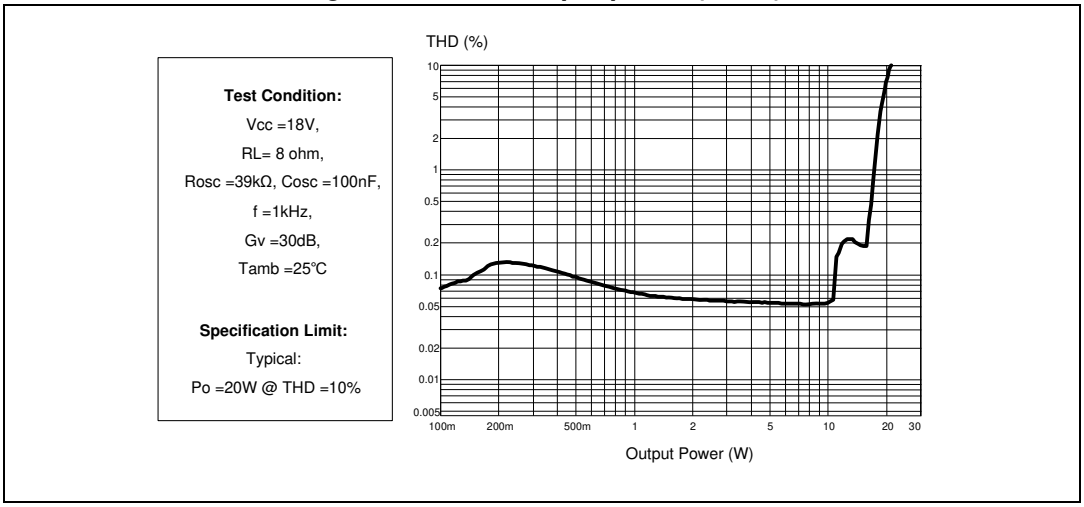


Figure 5. THD vs. output power (100 Hz)

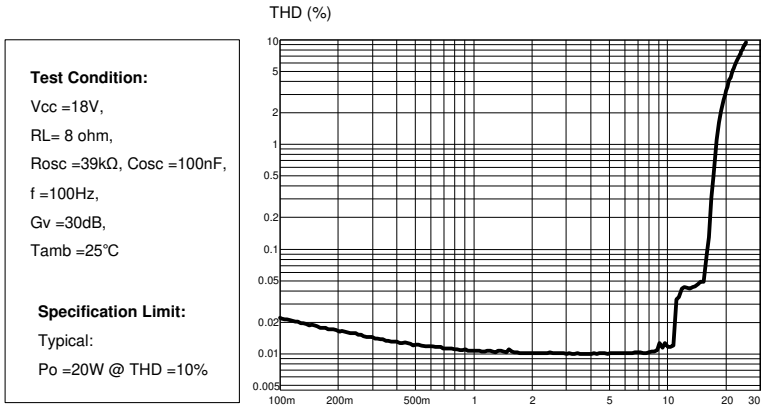


Figure 6. THD vs. frequency

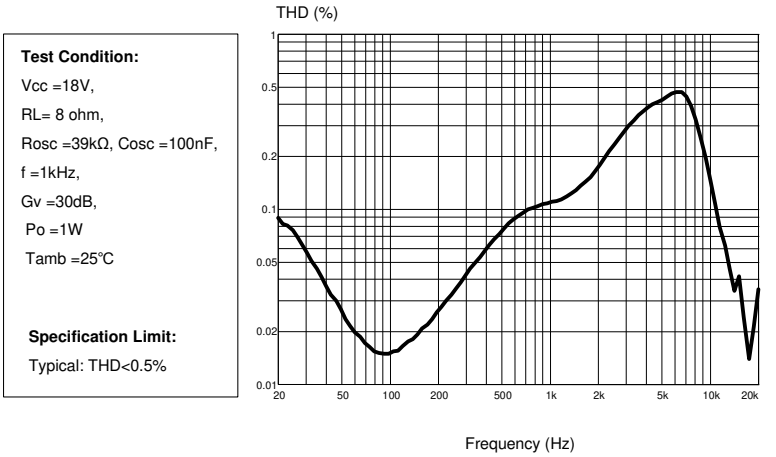


Figure 7. Frequency response

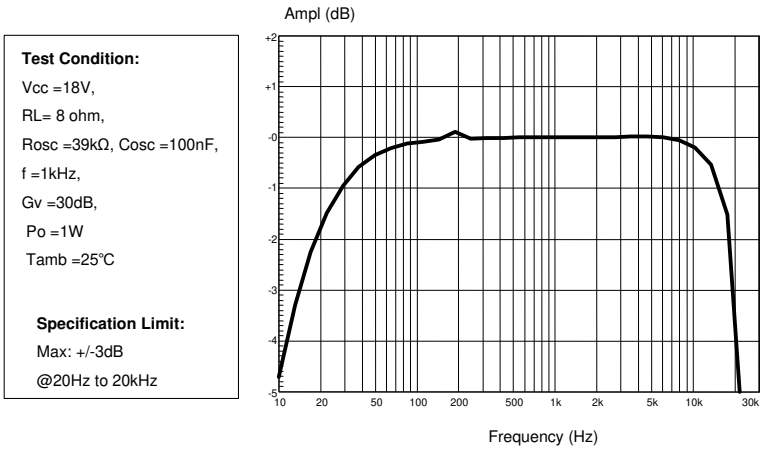


Figure 8. FFT (0 dB)

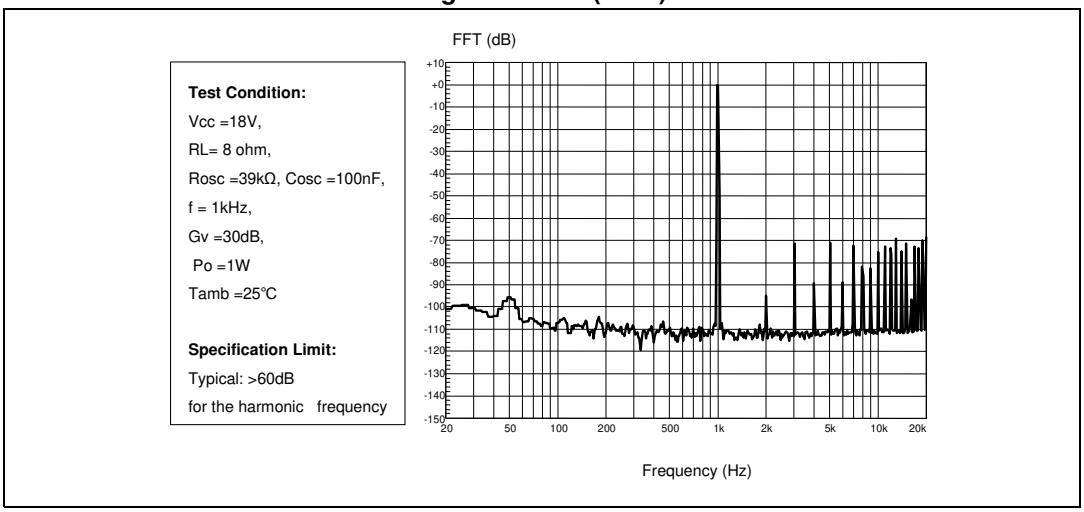


Figure 9. FFT (-60 dB)

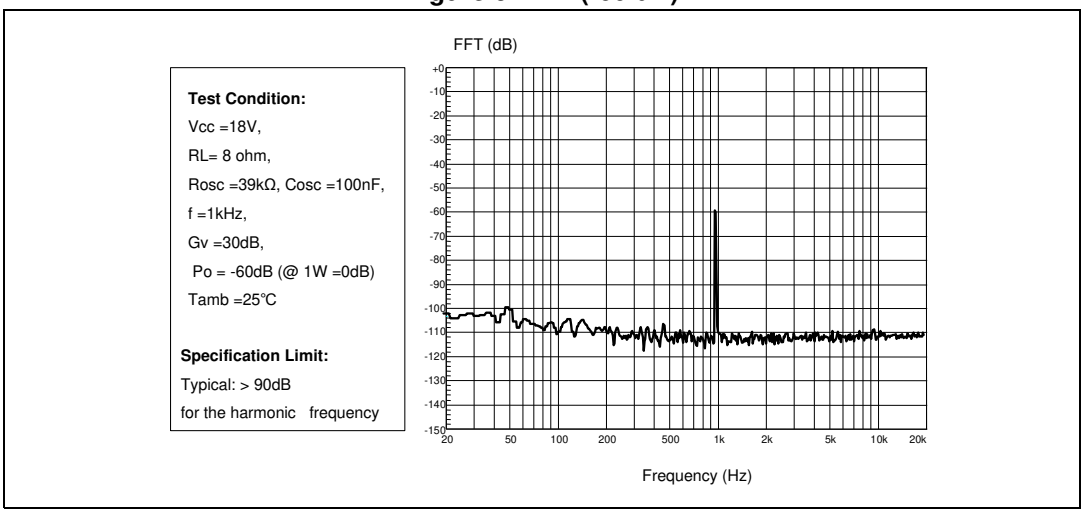


Figure 10. Closed-loop gain vs. frequency

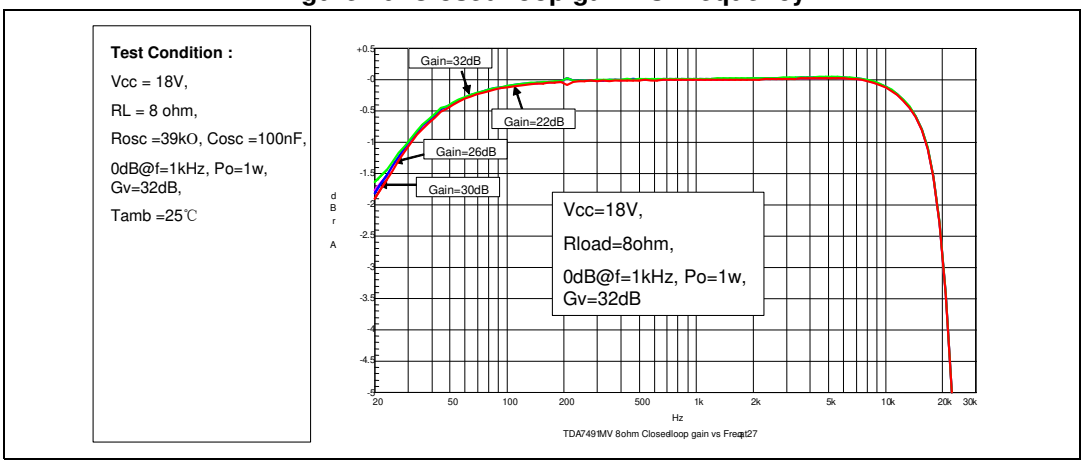


Figure 11. Power dissipation and efficiency vs. output power

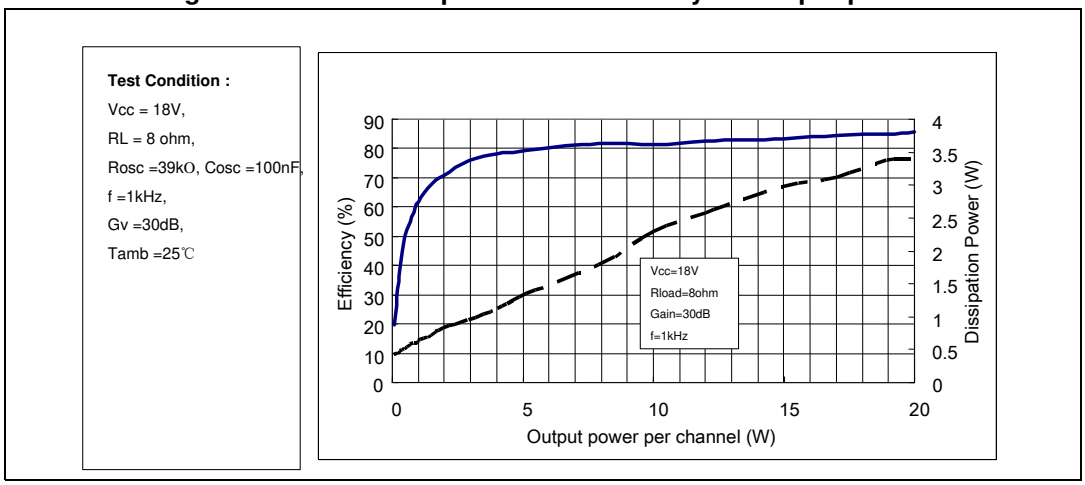


Figure 12. Attenuation vs. mute voltage

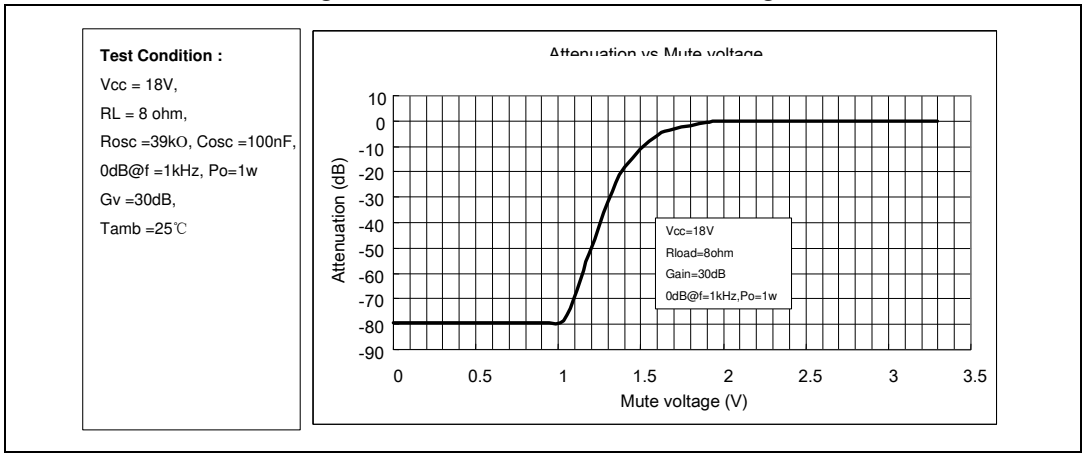


Figure 13. Current consumption vs. voltage on pin STBY

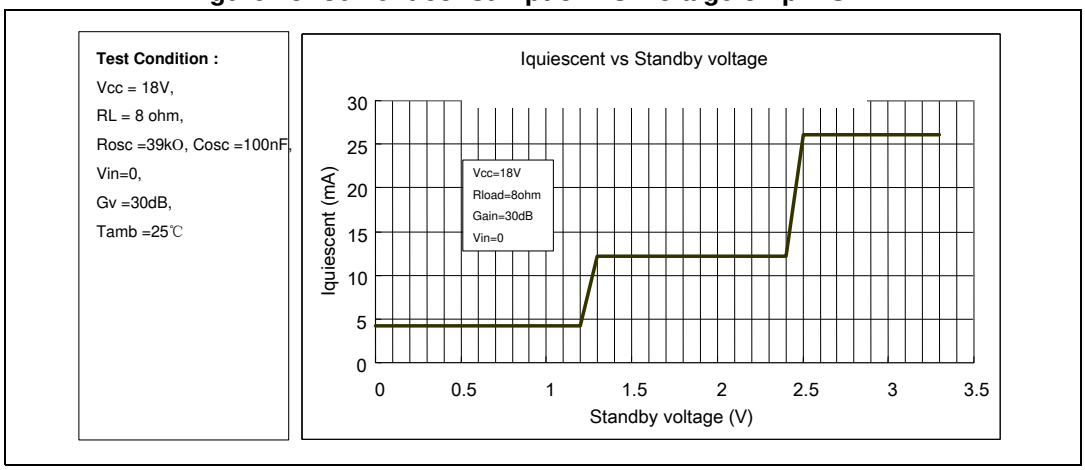


Figure 14. Attenuation vs. voltage on pin STBY

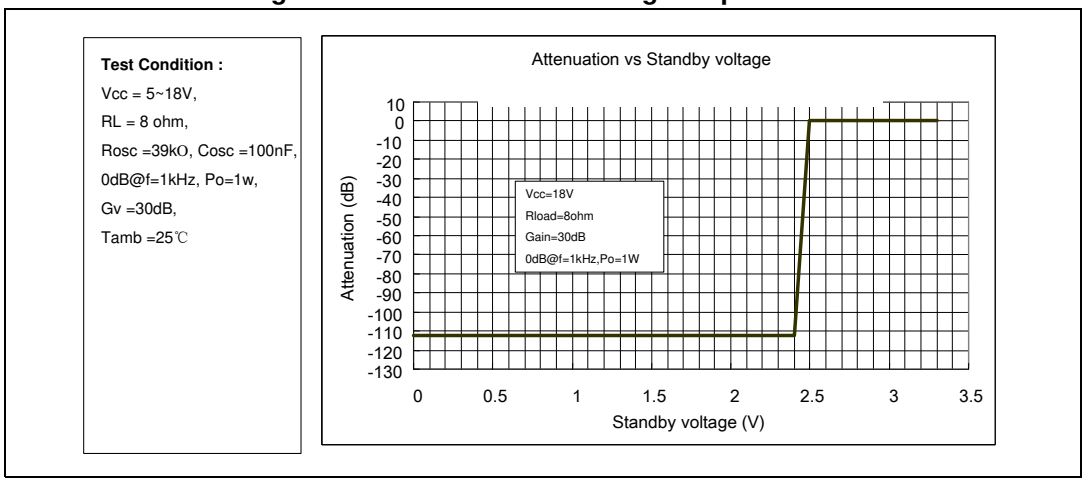
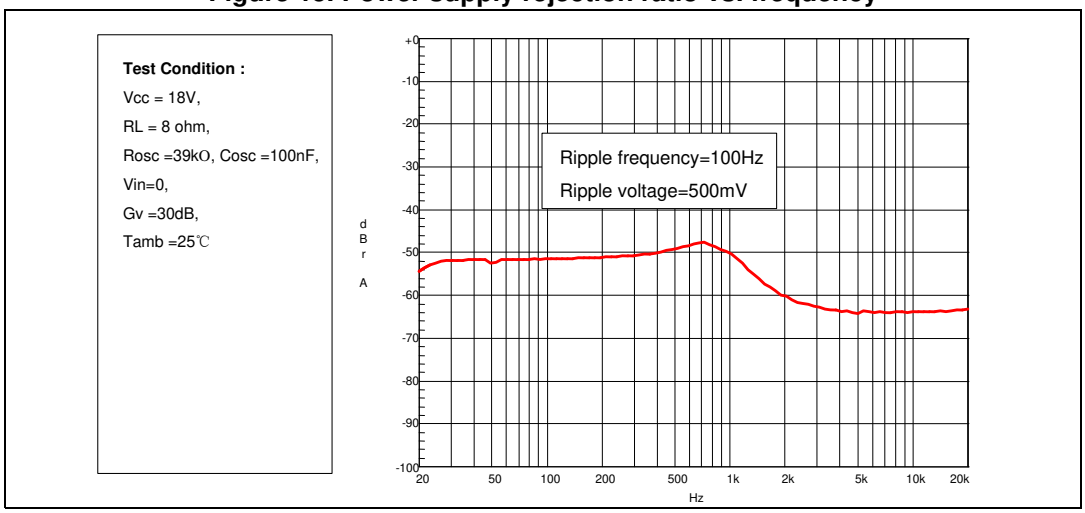
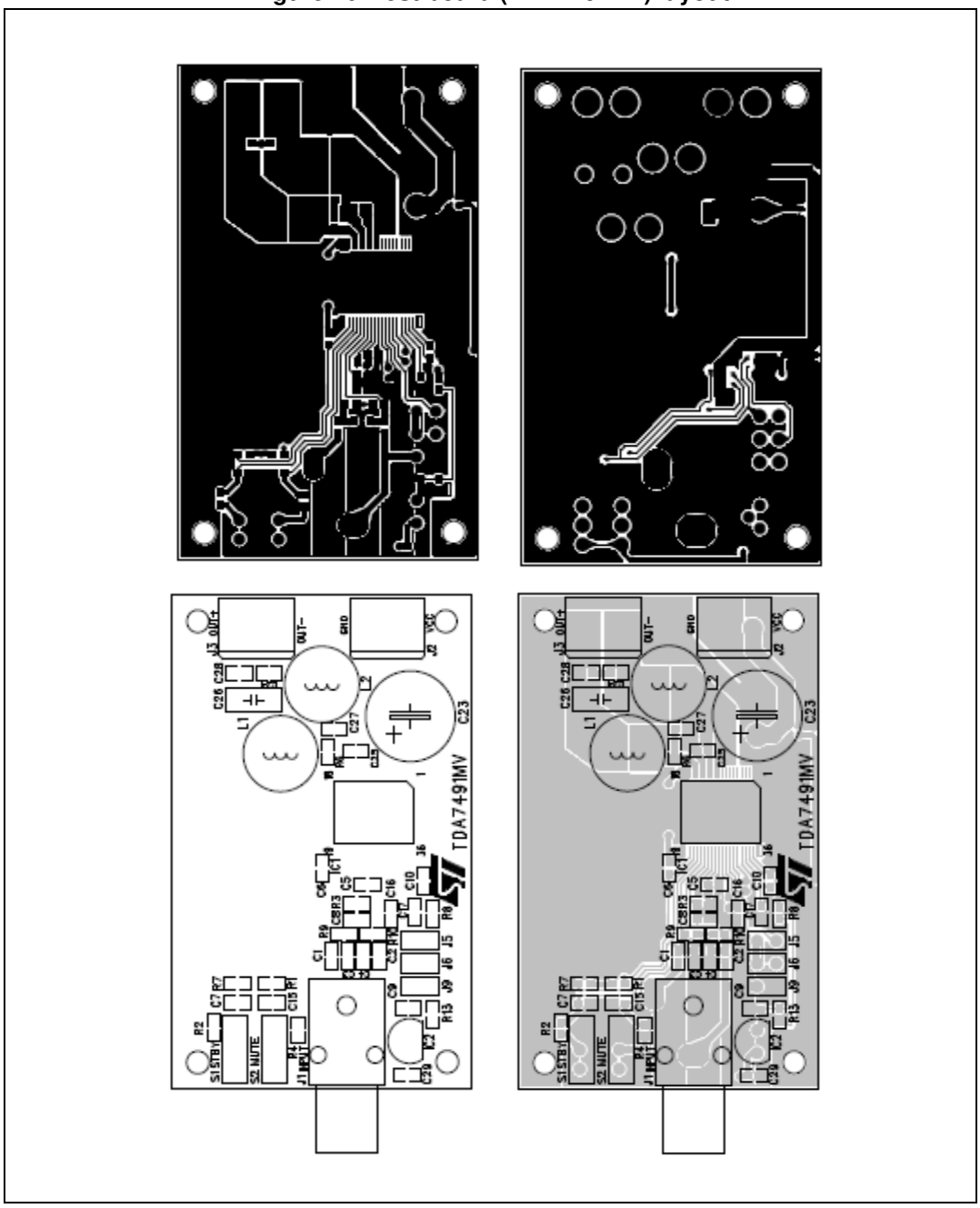


Figure 15. Power supply rejection ratio vs. frequency



4.1 Test board

Figure 16. Test board (TDA7491HV) layout



5 Package mechanical data

The TDA7491MV comes in a 36-pin PowerSSO package with exposed pad down.

Figure 17 below shows the package outline and *Table 6* gives the dimensions.

Figure 17. PowerSSO-36 EPD outline drawing

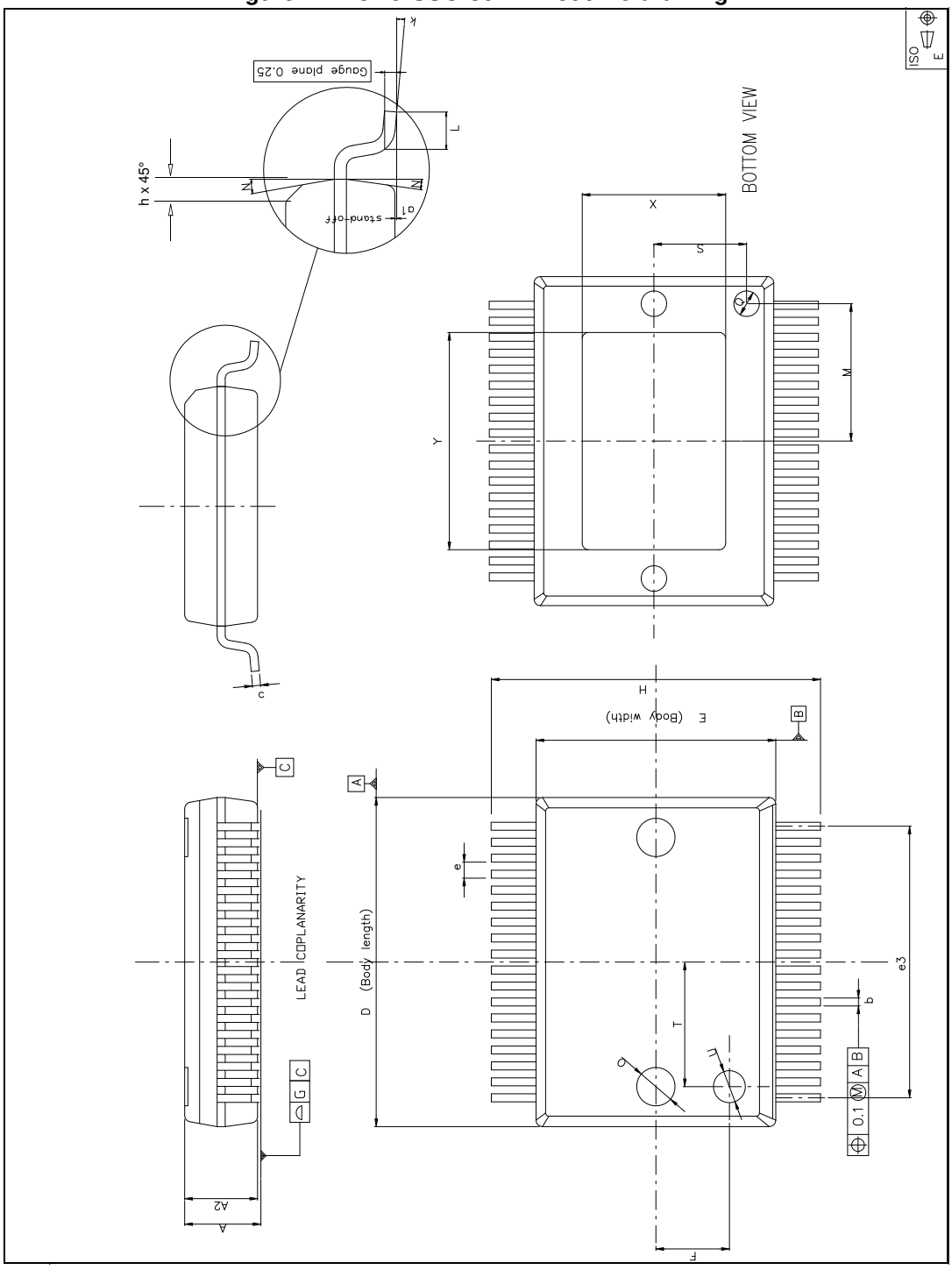


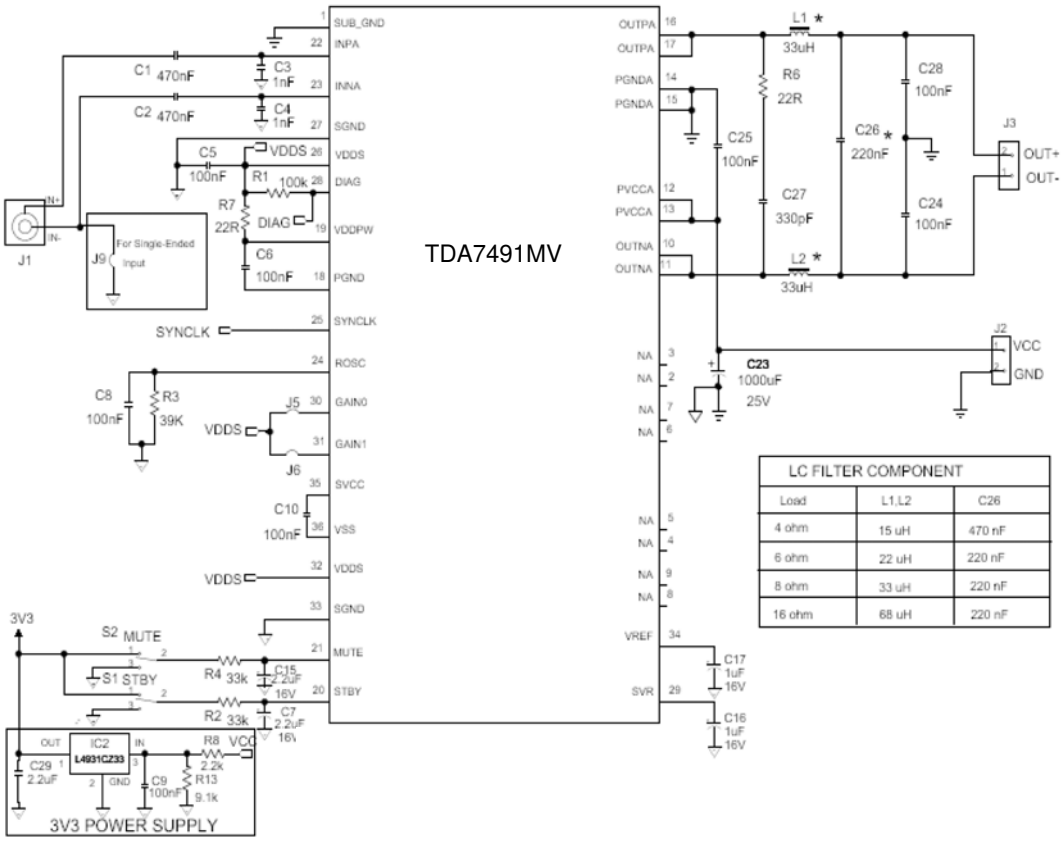
Table 6. PowerSSO-36 EPD dimensions

Symbol	Dimensions in mm			Dimensions in inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.15	-	2.47	0.085	-	0.097
A2	2.15	-	2.40	0.085	-	0.094
a1	0.00	-	0.10	0.000	-	0.004
b	0.18	-	0.36	0.007	-	0.014
c	0.23	-	0.32	0.009	-	0.013
D	10.10	-	10.50	0.398	-	0.413
E	7.40	-	7.60	0.291	-	0.299
e	-	0.5	-	-	0.020	-
e3	-	8.5	-	-	0.335	-
F	-	2.3	-	-	0.091	-
G	-	-	0.10	-	-	0.004
H	10.10	-	10.50	0.398	-	0.413
h	-	-	0.40	-	-	0.016
k	0	-	8 degrees	0	-	8 degrees
L	0.60	-	1.00	0.024	-	0.039
M	-	4.30	-	-	0.169	-
N	-	-	10 degrees	-	-	10 degrees
O	-	1.20	-	-	0.047	-
Q	-	0.80	-	-	0.031	-
S	-	2.90	-	-	0.114	-
T	-	3.65	-	-	0.144	-
U	-	1.00	-	-	0.039	-
X	4.10	-	4.70	0.161	-	0.185
Y	6.50	-	7.10	0.256	-	0.280

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK® is an ST trademark.

6 Applications circuit

Figure 18. Applications circuit for class-D amplifier



Input settings for gain:

GAIN0 : GAIN1	Nominal gain
0 V : 0 V	20 dB
0 V : 3.3 V	26 dB
3.3 V : 0 V	30 dB
3.3 V : 3.3 V	32 dB

Input settings for standby, mute and play:

STBY : MUTE	Mode
0 V : 0 V	Standby
0 V : 3.3 V	Standby
3.3 V : 0 V	Mute
3.3 V : 3.3 V	Play

6.1 Compatibility with TDA7491 stereo BTL family

TDA7491MV mono BTL analog class-D amplifier is derived from the TDA7491 stereo analog class-D BTL family. TDA7491MV has only the left channel of the stereo BTL family.

In order to guarantee the pin to pin compatibility when moving the application from stereo to mono, it is necessary to connect the right channel inputs (pins 32 and 33 of TDA7491 BTL family) to V_{CC} and GND, that is, pin 32 to VDDS and pin 33 to SGND.

7 Application information

7.1 Mode selection

The three operating modes of the TDA7491MV are set by the two inputs STBY (pin 20) and MUTE (pin 21).

- Standby mode: all circuits are turned off, very low current consumption.
- Mute mode: inputs are connected to ground and the positive and negative PWM outputs are at 50% duty cycle.
- Play mode: the amplifiers are active.

The protection functions of the TDA7491MV are realized by pulling down the voltages of the STBY and MUTE inputs shown in *Figure 19*. The input current of the corresponding pins must be limited to 200 µA.

Table 7. Mode settings

Mode Selection	STBY	MUTE
Standby	L (1)	X (don't care)
Mute	H (1)	L
Play	H	H

1. Drive levels defined in *Table 5: Electrical specifications on page 8*

Figure 19. Standby and mute circuits

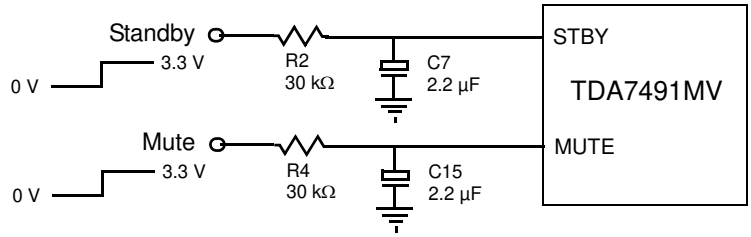
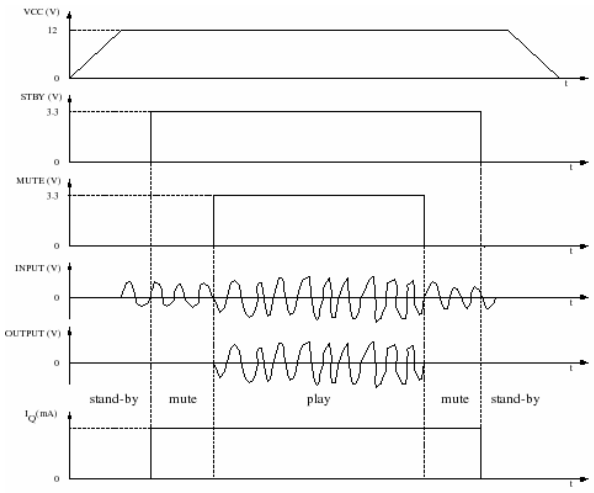


Figure 20. Turn-on/off sequence for minimizing speaker "pop"



7.2 Gain setting

The gain of the TDA7491MV is set by the two inputs, GAIN0 (pin 30) and GAIN1 (pin 31). Internally, the gain is set by changing the feedback resistors of the amplifier.

Table 8. Gain settings

GAIN0	GAIN1	Nominal gain, G_V (dB)
0	0	20
0	1	26
1	0	30
1	1	32

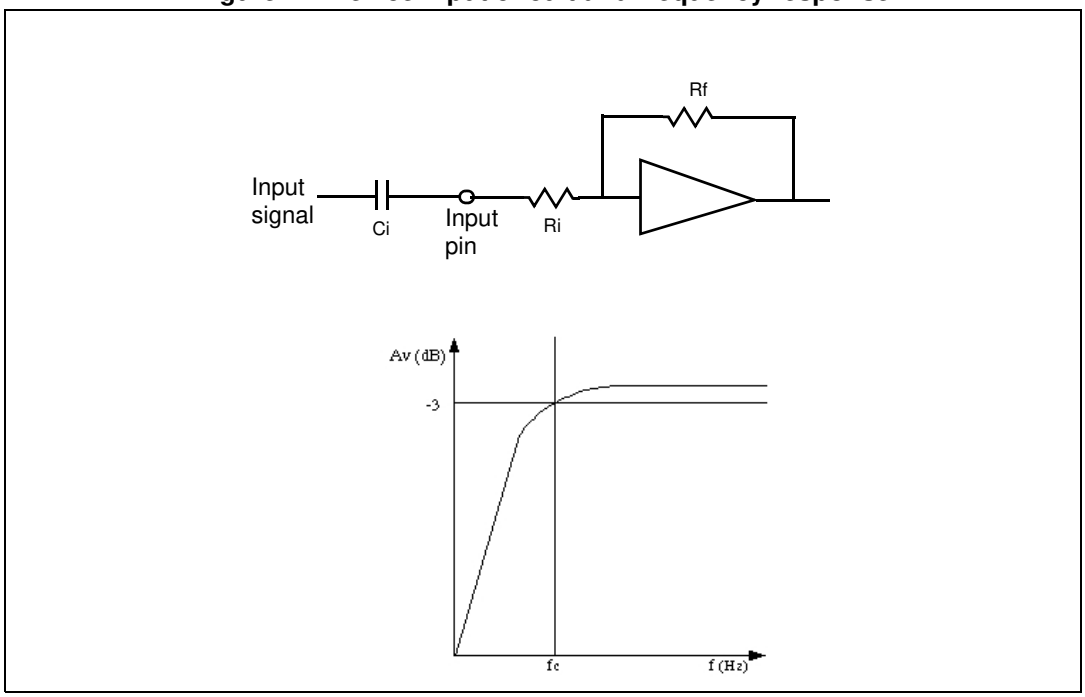
7.3 Input resistance and capacitance

The input impedance is set by an internal resistor Ri = 60 kΩ (typical). An input capacitor (Ci) is required to couple the AC input signal.

The equivalent circuit and frequency response of the input components are shown in *Figure 21*. For Ci = 220 nF the high-pass filter cut-off frequency is below 20 Hz:

$$fc = 1 / (2 * \pi * Ri * Ci)$$

Figure 21. Device input circuit and frequency response



7.4 Internal and external clocks

The clock of the class-D amplifier can be generated internally or can be driven by an external source.

If two or more class-D amplifiers are used in the same system, it is recommended that all devices operate at the same clock frequency. This can be implemented by using one TDA7491MV as master clock, while the other devices are in slave mode (that is, externally clocked. The clock interconnect is via pin SYNCLK of each device. As explained below, SYNCLK is an output in master mode and an input in slave mode.

7.4.1 Master mode (internal clock)

Using the internal oscillator, the output switching frequency, f_{SW}, is controlled by the resistor, R_{OSC}, connected to pin ROSC:

$$f_{SW} = 10^6 / ((16 * R_{OSC} + 182) * 4) \text{ kHz}$$

where R_{OSC} is in kΩ.

In master mode, pin SYNCLK is used as a clock output pin, whose frequency is:

$$f_{SYNCLK} = 2 * f_{SW}$$

For master mode to operate correctly then resistor R_{OSC} must be less than 60 kΩ as given below in *Table 9*.

7.4.2 Slave mode (external clock)

In order to accept an external clock input the pin ROSC must be left open, that is, floating. This forces pin SYNCLK to be internally configured as an input as given in *Table 9*.

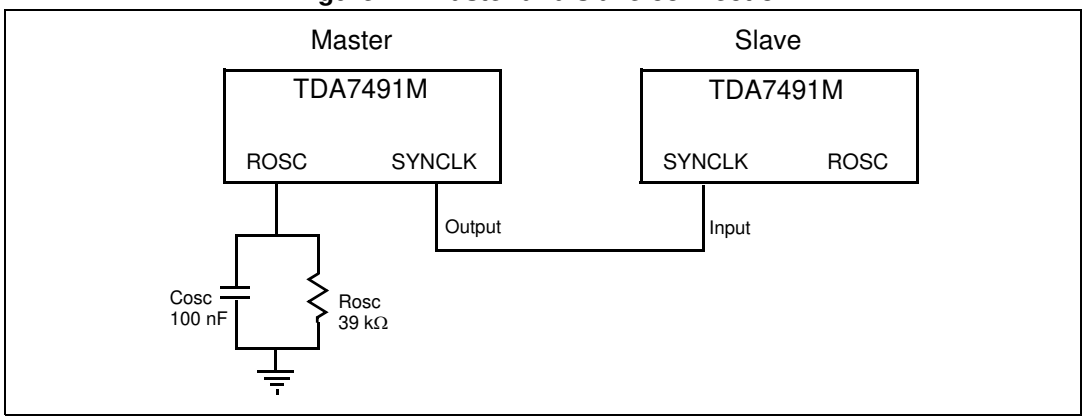
The output switching frequency of the slave devices is:

$$f_{SW} = f_{SYNCLK} / 2$$

Table 9. How to set up SYNCLK

Mode	ROSC	SYNCLK
Master	R_{OSC} < 60 kΩ	Output
Slave	Floating (not connected)	Input

Figure 22. Master and slave connection



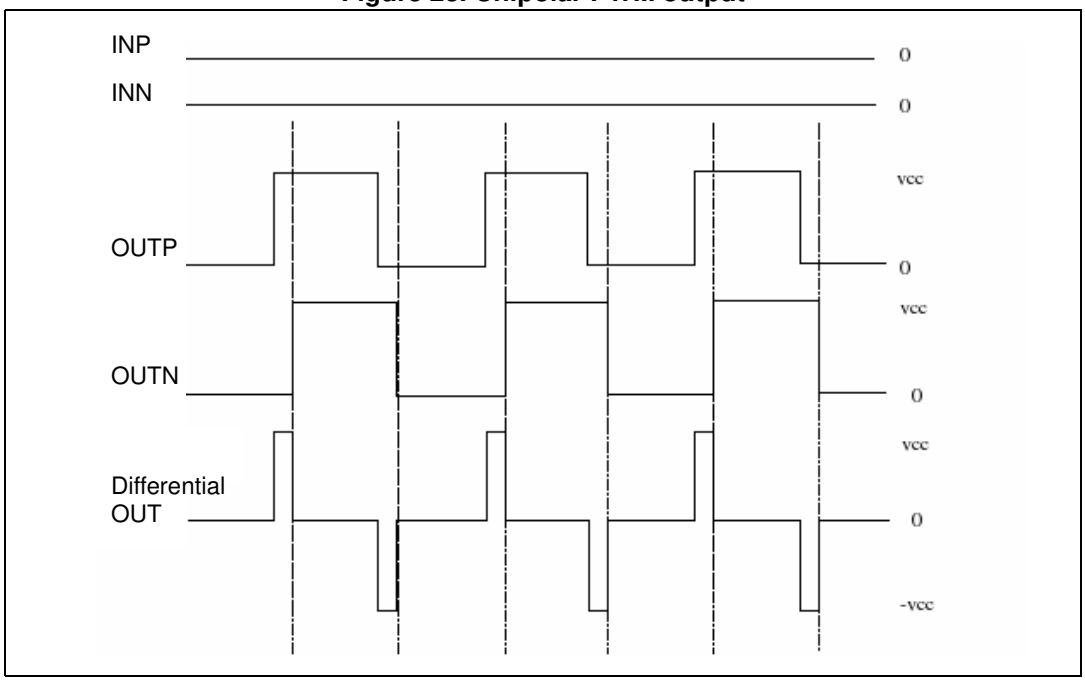
7.5 Filterless modulation

The output modulation scheme of the BTL is called unipolar pulse width modulation (PWM). The differential output voltages change between 0 V and $+V_{CC}$ and between 0 V and $-V_{CC}$. This is in contrast to the traditional bipolar PWM outputs which change between $+V_{CC}$ and $-V_{CC}$.

An advantage of this scheme is that it effectively doubles the switching frequency of the differential output waveform. The OUTP and OUTN are in the same phase when the input is zero, then the switching current is low and the loss in the load is small. In practice, a short delay is introduced between these two outputs in order to avoid the BTL output switching at the same time.

TDA7491MV can be used without a filter before the speaker, because the frequency of the TDA7491MV output is beyond the audio frequency, the audio signal can be recovered by the inherent inductance of the speaker and natural filter of the human ear.

Figure 23. Unipolar PWM output



7.6 Output low-pass filter

To avoid EMI problems, it may be necessary to use a low-pass filter before the speaker. The cutoff frequency should be larger than 22 kHz and much lower than the output switching frequency. It is necessary to choose the L-C component values depending on the loud speaker impedance. Some typical values, which give a cut-off frequency of 27 kHz, are shown in *Figure 24* and *Figure 25* below.

Figure 24. Typical LC filter for a 8 Ω speaker

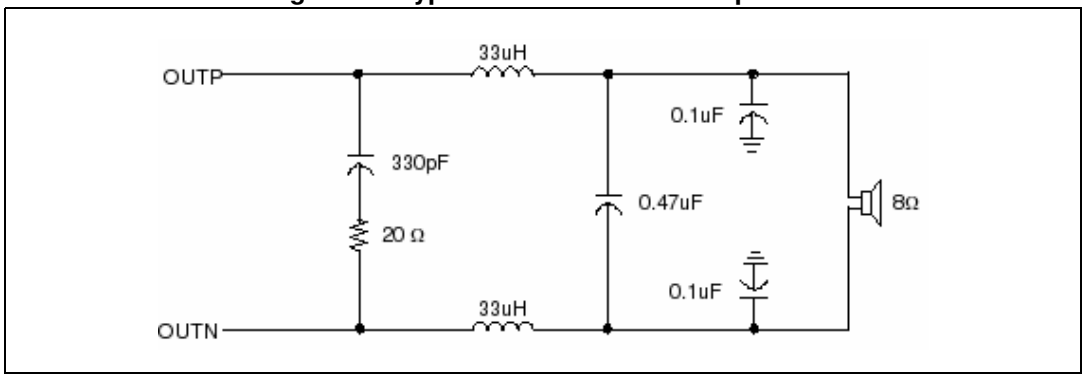
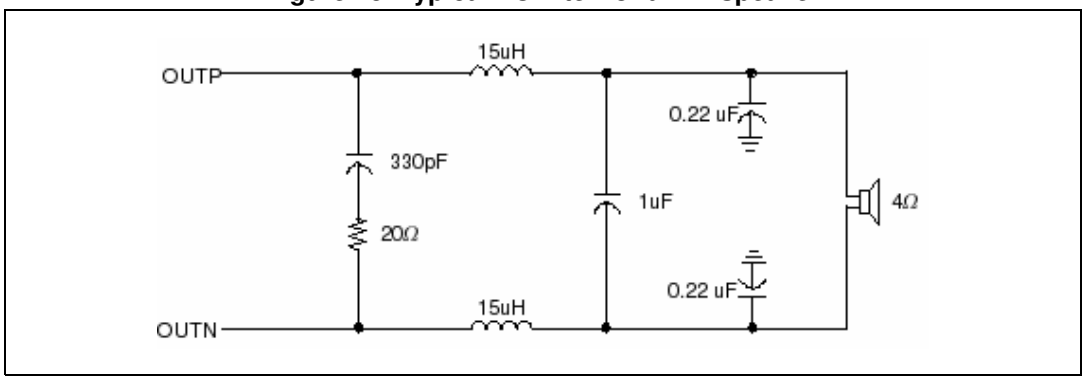


Figure 25. Typical LC filter for a 4 Ω speaker



7.7 Protection function

The TDA7491MV is fully protected against overvoltage, undervoltage, overcurrent and thermal overloads as explained here.

Overvoltage protection (OVP)

If the supply voltage exceeds the value for V_{OVP} given in *Table 5: Electrical specifications on page 8* the overvoltage protection is activated which forces the outputs to the high-impedance state. When the supply voltage drops to below the threshold value the device restarts.

Undervoltage protection (UVP)

If the supply voltage drops below the value for V_{UVP} given in *Table 5: Electrical specifications on page 8* the undervoltage protection is activated which forces the outputs to the high-impedance state. When the supply voltage recovers the device restarts.

Overcurrent protection (OCP)

If the output current exceeds the value for I_{OCP} given in *Table 5: Electrical specifications on page 8* the overcurrent protection is activated which forces the outputs to the high-impedance state. Periodically, the device attempts to restart. If the overcurrent condition is still present then the OCP remains active. The restart time, T_{OC}, is determined by the R-C components connected to pin STBY.

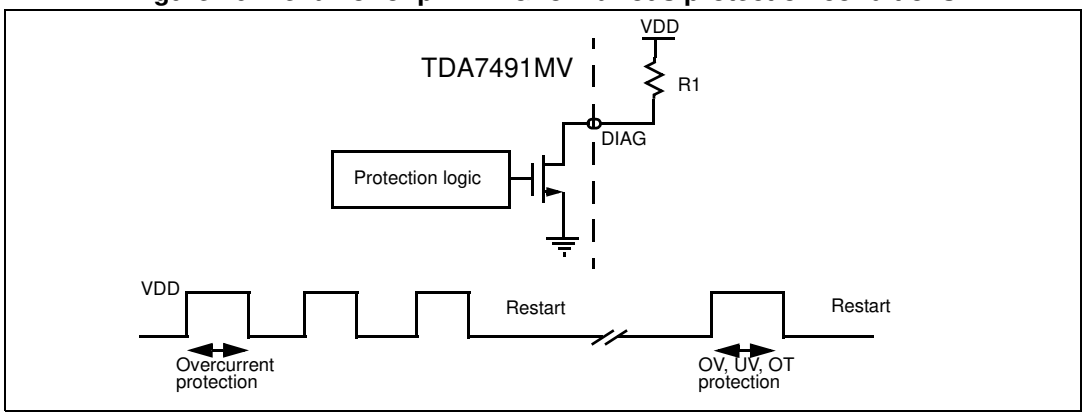
Thermal protection (OTP)

If the junction temperature, T_j, reaches 145 °C (nominal), the device goes to mute mode and the positive and negative PWM outputs are forced to 50% duty cycle. If the junction temperature exceeds the value for Tj given in *Table 5: Electrical specifications on page 8* the device shuts down and the output is forced to the high impedance state. When the device cools sufficiently the device restarts.

7.8 Diagnostic output

The output pin DIAG is an open drain transistor. When the protection is activated it is in the high-impedance state. The pin can be connected to a power supply (< 18 V) by a pull-up resistor whose value is limited by the maximum sinking current (200 µA) of the pin.

Figure 26. Behavior of pin DIAG for various protection conditions



7.9 Heatsink requirements

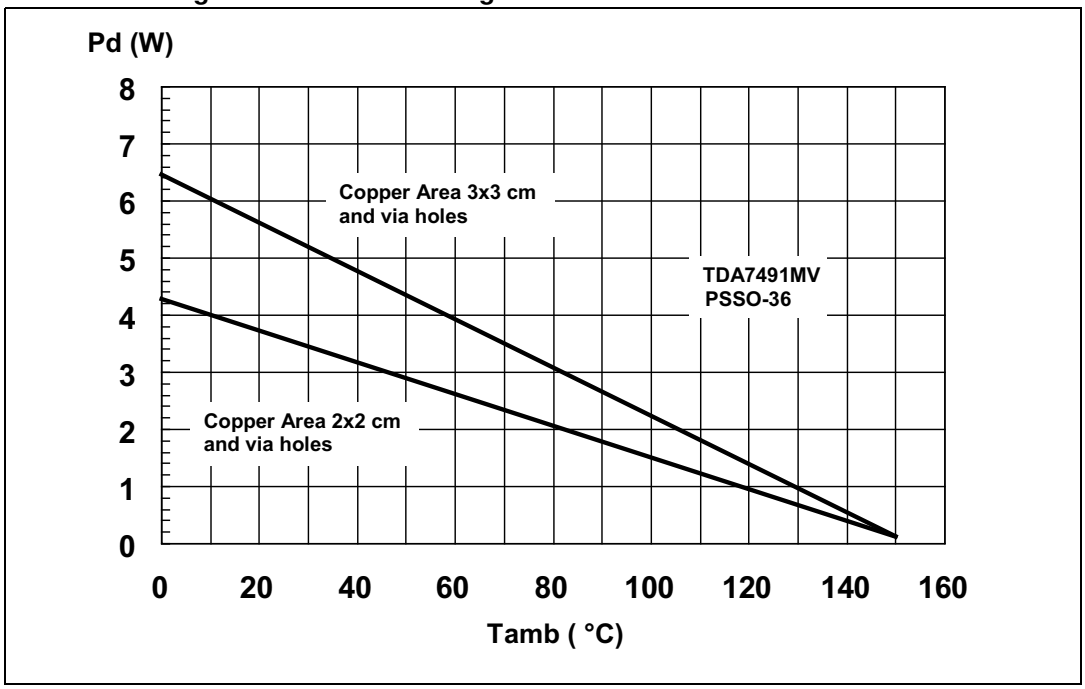
A thermal resistance of 24 °C/W can be obtained using the PCB copper ground layer with 16 vias connecting it to the contact area for the exposed pad. Ensure that the copper ground area is a nominal 9 cm^2 for 24 °C/W.

Figure 27 shows the derating curves for copper areas of 4 cm^2 and 9 cm^2.

As with most amplifiers, the power dissipated within the device depends primarily on the supply voltage, the load impedance and the output modulation level.

The maximum estimated power dissipation for the TDA7491MV is less than 4 W. When properly mounted on the above PCB the junction temperature could increase by 96 °C. However, with a musical program the dissipated power is about 40% less, leading to a temperature increase of around 60 °C. Even at the maximum recommended ambient temperature for consumer applications of 50 °C there is still a clear safety margin before the maximum junction temperature (150 °C) is reached.

Figure 27. Power derating curves for PCB used as heatsink



8 Revision history

Table 10. Document revision history

Date	Revision	Changes
21-Oct-2008	1	Initial release.
29-May-2009	2	Updated text concerning oscillator R and C in *Section 3.3: Electrical specifications on page 8* Updated test condition for Iq, added V_{UVP}, updated STBY and MUTE voltages and rectified several anomalies in *Table 5: Electrical specifications on page 8* Updated equation for f_{SW} *on page 10* and *on page 22* Updated *Figure 16: Test board (TDA7491HV) layout on page 16* Updated *Figure 17: PowerSSO-36 EPD outline drawing on page 17* and *Table 6: PowerSSO-36 EPD dimensions on page 18* Updated *Figure 18: Applications circuit for class-D amplifier on page 19*
20-Feb-2014	3	Updated order code *Table 1 on page 1*
21-Mar-2014	4	Updated operating temperature range from 0 to 70 °C in - 40 to 85 °C *Table 1 on page 1* and *Table 3 on page 8*

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